SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

FEATURES

- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, All Outputs Are in the High-Impedance State
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over Full 1.2-V to 3.6-V Power-Supply Range
- I_{off} Supports Partial-Power-Down Mode Operation
- I/Os Are 4.6-V Tolerant
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ORDERING INFORMATION

This 24-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVC24T245 is optimized to operate with V_{CCA}/V_{CCB} set at 1.4 V to 3.6 V. It is operational with V_{CCA}/V_{CCB} as low as 1.2 V. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVC24T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVC24T245 is designed so that the control pins (1DIR, 2DIR, 3DIR, 4DIR, 5DIR, 6DIR, $\overline{10E}$, $\overline{20E}$, $\overline{30E}$, $\overline{40E}$, $\overline{50E}$, and $\overline{60E}$) are supplied by V_{CCA} .

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CCA} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
40°C to 95°C	LFBGA – GRG	Tape and reel	SN74AVC24T245GRGR	WH245
–40°C to 85°C	LFBGA – ZRG (Pb-free)	Tape and reel	SN74AVC24T245ZRGR	VVH245

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

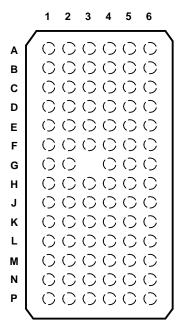


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

GRG OR ZRG PACKAGE (TOP VIEW)



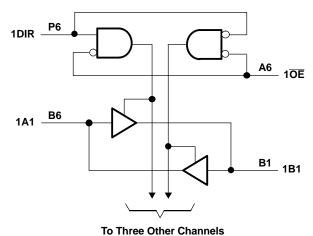
TERMINAL FUNCTIONS

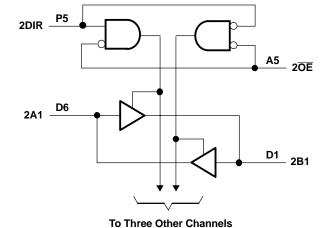
	1	2	3	4	5	6
Α	6 OE	5 OE	4 OE	3 OE	2 OE	1 OE
В	1B1	1B2	V _{CCB}	V _{CCA}	1A2	1A1
С	1B3	1B4	GND	GND	1A4	1A3
D	2B1	2B2	V _{CCB}	V_{CCA}	2A2	2A1
Е	2B3	2B4	GND	GND	2A4	2A3
F	3B1	3B2	GND	GND	3A2	3A1
G	3B3	3B4		GND	3A4	3A3
Н	4B1	4B2	V _{CCB}	V _{CCA}	4A2	4A1
J	4B3	4B4	GND	GND	4A4	4A3
K	5B1	5B2	GND	GND	5A2	5A1
L	5B3	5B4	V _{CCB}	V _{CCA}	5A4	5A3
М	6B1	6B2	GND	GND	6A2	6A1
N	6B3	6B4	V _{CCB}	V _{CCA}	6A4	6A3
Р	6DIR	5DIR	4DIR	3DIR	2DIR	1DIR

FUNCTION TABLE (EACH 4-BIT SECTION)

•		•
INP	UTS	OPERATION
ŌĒ	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Х	Isolation

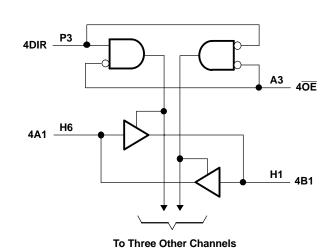
LOGIC DIAGRAM (POSITIVE LOGIC)

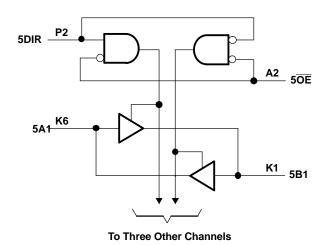


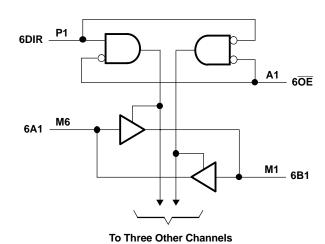


3DIR P4 3OE 3A1 F6 F1 3B1

To Three Other Channels









SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CCA} V _{CCB}	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
V_{I}	Input voltge range ⁽²⁾	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output	A port	-0.5	4.6	V
Vo	in the high-impedance or power-off state (2)	B port	-0.5	0.5 4.6 0.5 4.6 0.5 4.6 0.5 4.6 0.5 4.6 0.5 4.6 0.5 V _{CCA} + 0.5 0.5 V _{CCB} + 0.5 -50 ±50 ±100 50	V
W	Valtage response and in the convention to the label and an extent (2)(3)	A port	-0.5	V _{CCA} + 0.5	V
Vo	Voltage range applied to any output in the high or low state (2)(3)	B port	-0.5	V _{CCB} + 0.5	V
I _{IK}	Input clamp current	V _I < 0		-50	mA
l _{OK}	Output clamp current	V _O < 0		-50	mA
Io	Continuous output current	·		±50	mA
	Continuous current through each V _{CCA} , V _{CCB} , and GND			±100	mA
θ_{JA}	Package thermal impedance (4)	GRG/ZRG package		50	°C/W
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

The package thermal impedance is calculated in accordance with JESD 51-7.



SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

Recommended Operating Conditions (1)(2)(3)

			V _{CCI}	V _{cco}	MIN	MAX	UNIT
V _{CCA}	Supply voltage				1.2	3.6	V
V _{CCB}	Supply voltage				1.2	3.6	V
			1.2 V to 1.95 V		V _{CCI} × 0.65		
V_{IH}	High-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V		1.6		V
	input voltage		2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCI} \times 0.35$	
V_{IL}	Low-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V			0.7	V
	input voltage		2.7 V to 3.6 V			0.8	
			1.2 V to 1.95 V		$V_{CCA} \times 0.65$		
V_{IH}	High-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V		1.6		V
	input voltage	(referenced to ACCV)	2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCA} \times 0.35$	
V_{IL}	Low-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V			0.7	V
	input voitage	(referenced to ACCV)	2.7 V to 3.6 V			0.8	
V _I	Input voltage	<u> </u>			0	3.6	V
\/	Outrut valtage	Active state			0	V _{cco}	1/
V_{O}	Output voltage	3-state			0	3.6	V
		<u> </u>		1.2 V		-3	
				1.4 V to 1.6 V		-6	
I_{OH}	High-level output curr	ent		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
I _{OL}	Low-level output curre	ent		1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
Δt/Δν	Input transition rise or	fall rate				5	ns/V
T _A	Operating free-air ten	perature			-40	85	°C

V_{CCI} is the V_{CC} associated with the data input port.
 V_{CCO} is the V_{CC} associated with the output port.
 All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
 For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V.
 For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.



SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (1)(2)

PARAMETER		TEST CONDI	TIONS	V	V	T,	գ = 25°C		–40°C to 85	UNIT	
PARA	AIVIETER	IESI CONDI	HONS	V _{CCA}	V _{CCB}	MIN	TYP	MAX	MIN	MAX	UNII
		$I_{OH} = -100 \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V				V _{CCO} - 0.2		
		$I_{OH} = -3 \text{ mA}$		1.2 V	1.2 V		0.95				
\/		$I_{OH} = -6 \text{ mA}$	\/ \/	1.4 V	1.4 V				1.05		V
V_{OH}		$I_{OH} = -8 \text{ mA}$	$V_I = V_{IH}$	1.65 V	1.65 V				1.2		V
		$I_{OH} = -9 \text{ mA}$		2.3 V	2.3 V				1.75		
		I _{OH} = -12 m		3 V	3 V				2.3		
		$I_{OL} = 100 \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	
		I _{OL} = 3 mA		1.2 V	1.2 V		0.15				
\/		I _{OL} = 6 mA	., .,	1.4 V	1.4 V					0.35	V
V_{OL}		I _{OL} = 8 mA	$V_I = V_{IL}$	1.65 V	1.65 V					0.45	V
		I _{OL} = 9 mA		2.3 V	2.3 V					0.55	
		I _{OL} = 12 mA		3 V	3 V					0.7	
I	Control inputs	V _I = V _{CCA} or GNE)	1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μΑ
	A or B port			0 V	0 to 3.6 V		±0.1	±2.5		±5	^
l _{off}	A or B port	$V_1 \text{ or } V_0 = 0 \text{ to } 3.6$	o V	0 to 3.6 V	0 V		±0.1	±2.5		±5	μΑ
I _{OZ} (3)	A or B port	$V_O = V_{CCO}$ or GN $V_I = V_{CCI}$ or GND $\overline{OE} = V_{IH}$	D, ,	3.6 V	3.6 V		±0.5	±2.5		±5	μΑ
				1.2 V to 3.6 V	1.2 V to 3.6 V					40	
I_{CCA}		$V_I = V_{CCI}$ or GND $I_O = 0$,	0 V	3.6 V					-5	μΑ
		10 = 0		3.6 V	0 V					40	
				1.2 V to 3.6 V	1.2 V to 3.6 V					40	
I_{CCB}		$V_I = V_{CCI}$ or GND $I_O = 0$,	0 V	3.6 V					40	μΑ
		10 – 0		3.6 V	0 V					-5	
I _{CCA} +	I _{CCB}	$V_I = V_{CCI}$ or GND $I_O = 0$,	1.2 V to 3.6 V	1.2 V to 3.6 V					75	μΑ
C _i	Control inputs	V _I = 3.3 V or GNI)	3.3 V	3.3 V		3.5				pF
C _{io}	A or B port	V _O = 3.3 V or GN	D	3.3 V	3.3 V		7				pF

 ⁽¹⁾ V_{CCO} is the V_{CC} associated with the output port.
 (2) V_{CCI} is the V_{CC} associated with the input port.
 (3) For I/O ports, the parameter I_{OZ} includes the input leakage current.

SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (see Figure 1)

PARAMETER	FROM	то	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V	V _{CCB} = 1.8 V	$V_{CCB} = 2.5 V$	V _{CCB} = 3.3 V	UNIT					
PARAMETER	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	UNIT					
t _{PLH}	Α	В	4.1	3.3	3	2.8	3.2	200					
t _{PHL}	A	Б	4.1	3.3	3	2.8	3.2	ns					
t _{PLH}	В	Α	4.4	4	3.8	3.6	3.5	ns					
t _{PHL}	Ь		4.4	4	3.8	3.6	3.5	115					
t _{PZH}	ŌĒ	Α	6.4	6.4	6.4	6.4	6.4	no					
t _{PZL}	OE	A	6.4	6.4	6.4	6.4	6.4	ns					
t _{PZH}	ŌĒ	D	6	4.6	4	3.4	3.2	200					
t _{PZL}	OL OL	В	6	4.6	4	3.4	3.2	ns					
t _{PHZ}	OE		6.6	6.6	6.6	6.6	6.8	ns					
t _{PLZ}	OL	Α	6.6	6.6	6.6	6.6	6.8	115					
t _{PHZ}	- OE	В	В	В	6	4.9	4.9	4.2	5.3	ne			
t _{PLZ}	OE				В	В	В	В	В	В	6	4.9	4.9

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.7	1.5 V I V	V _{CCB} = ± 0.1		V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		UNIT																	
	(INPOT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX																		
t _{PLH}	А	В	3.6	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	20																	
t _{PHL}	A	Б	3.6	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	ns																	
t _{PLH}	В	A	3.3	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	no																	
t _{PHL}	В	Б	A	3.3	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	ns																
t _{PZH}	ŌĒ	A	4.3	1	10.1	1	10.1	1	10.1	1	10.1	200																	
t _{PZL}	OE	OE	A	4.3	1	10.1	1	10.1	1	10.1	1	10.1	ns																
t _{PZH}	ŌĒ	В	5.6	1	10.1	0.5	8.1	0.5	5.9	0.5	5.2	no																	
t _{PZL}	OE	Ь	5.6	1	10.1	0.5	8.1	0.5	5.9	0.5	5.2	ns																	
t _{PHZ}	OE	^	4.5	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	ns																	
t _{PLZ}	ŌĒ	Α	4.5	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	115																	
t _{PHZ}	OE .	В	5.5	1.5	8.7	1.5	7.5	1	6.5	1	6.3	20																	
t _{PLZ}	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	В	5.5	1.5	8.7	1.5	7.5	1	6.5	1	6.3	ns

TEXAS INSTRUMENTS www.ti.com

SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 1)

PARAMETER	FROM	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V_{CCB} = 1.5 V \pm 0.1 V		V _{CCB} = 1.8 V ± 0.15 V		V_{CCB} = 2.5 V \pm 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT																		
	(INFOT)	(001F01)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX																				
t _{PLH}	А	В	3.4	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3	no																			
t _{PHL}	A	Ь	3.4	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3	ns																			
t _{PLH}	В	Α	3	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	ns																			
t _{PHL}	В	d	A	3	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	115																		
t _{PZH}	ŌĒ	Α	3.4	1	7.8	1	7.8	1	7.8	1	7.8	no																			
t _{PZL}	OE	A	3.4	1	7.8	1	7.8	1	7.8	1	7.8	ns																			
t _{PZH}	ŌĒ	В	5.4	1	9.2	0.5	7.4	0.5	5.3	0.5	4.5	ns																			
t _{PZL}	OE	Ь	5.4	1	9.2	0.5	7.4	0.5	5.3	0.5	4.5	115																			
t _{PHZ}	OE	۸	4.2	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	ns																			
t_{PLZ}	ŌĒ	Α	4.2	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	115																			
t _{PHZ}	OE.	D	5.2	1.5	8.4	1.5	7.1	1	5.9	1	5.7	no																			
t _{PLZ}	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	OE B	5.2	1.5	8.4	1.5	7.1	1	5.9	1	5.7	ns

Switching Characteristics

over recommended operating free-air temperature range, $\rm V_{CCA}$ = 2.5 V \pm 0.2 V (see Figure 1)

PARAMETER	FROM	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	= 1.2 V $\begin{vmatrix} V_{CCB} = 1.5 \text{ V} \\ \pm 0.1 \text{ V} \end{vmatrix}$ $\begin{vmatrix} V_{CCB} = 1.8 \text{ V} \\ \pm 0.15 \text{ V} \end{vmatrix}$			V _{CCB} = 2.5 V ± 0.2 V		V_{CCB} = 3.3 V \pm 0.3 V		UNIT		
	(INFOT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX			
t _{PLH}	۸	В	3.2	0.5	5.6	0.5	4.5	0.5	3.3	0.5	2.8	20		
t _{PHL}	Α	Б	3.2	0.5	5.6	0.5	4.5	0.5	3.3	0.5	2.8	ns		
t _{PLH}	В	Α	2.6	0.5	4.1	0.5	3.7	0.5	3.3	0.5	3.2			
t _{PHL}	В	D	A	2.6	0.5	4.1	0.5	3.7	0.5	3.3	0.5	3.2	ns	
t _{PZH}	ŌĒ	^	2.5	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	20		
t _{PZL}	OE .	Α	2.5	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	ns		
t _{PZH}	ŌĒ	В	5.2	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5	20		
t _{PZL}	OE .	Б	5.2	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5	ns		
t _{PHZ}	OE	^	3	1	6.1	1	6.1	1	6.1	1	6.1	20		
t _{PLZ}	ŌĒ	Α	3	1	6.1	1	6.1	1	6.1	1	6.1	ns		
t _{PHZ}	OE	В	5	1	7.9	1	6.6	1	6.1	1	5.2	20		
t _{PLZ}	ŌĒ	ŌĒ	ŌĒ	В	5	1	7.9	1	6.6	1	6.1	1	5.2	ns

SCES552C-FEBRUARY 2004-REVISED AUGUST 2005

Switching Charactertistics

over recommended operating free-air temperature range, $\rm V_{CCA}$ = 3.3 V \pm 0.3 V (see Figure 1)

PARAMETER	FROM		TO (OUTPUT)	V _{CCB} = 1.2 V	V_{CCB} = 1.5 V \pm 0.1 V		V _{CCB} = 1.8 V ± 0.15 V		V_{CCB} = 2.5 V \pm 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT								
	(INPUT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX										
t _{PLH}	А	В	3.2	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7	20									
t _{PHL}	A	Ь	3.2	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7	ns									
t _{PLH}	В	Α	2.8	0.5	3.7	0.5	3.3	0.5	2.8	0.5	2.7	ns									
t _{PHL}	В	D	A	2.8	0.5	3.7	0.5	3.3	0.5	2.8	0.5	2.7	115								
t _{PZH}	ŌĒ	Α	2.2	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4	20									
t _{PZL}	OE	A	2.2	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4	ns									
t _{PZH}	ŌĒ	В	5.1	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4	ns									
t _{PZL}	OE	Ь	5.1	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4	115									
t _{PHZ}	OE	۸	3.4	0.5	5	0.5	5	0.5	5	0.5	5	ns									
t _{PLZ}	ŌĒ	OE A	3.4	0.5	5	0.5	5	0.5	5	0.5	5	115									
t _{PHZ}	ŌĒ	ŌĒ	В	4.9	1	7.7	1	6.5	1	5.2	0.5	5	20								
t _{PLZ}			ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ם	4.9	1	7.7	1	6.5	1	5.2	0.5

Operating Characteristics

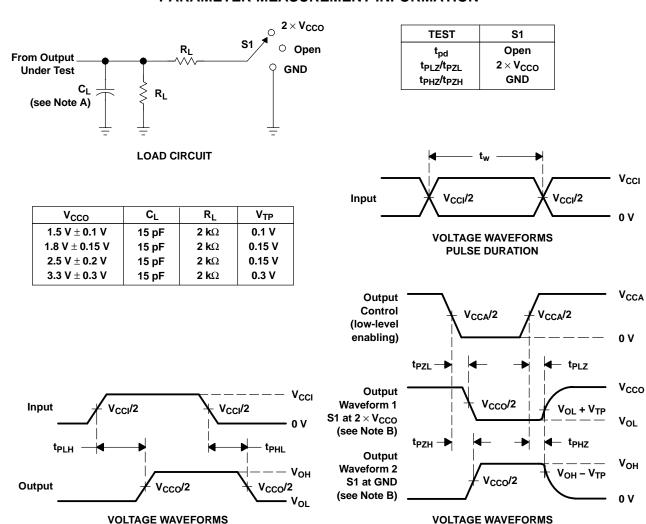
 $\rm V_{CCA}$ and $\rm V_{CCB} = 3.3~V,~T_A = 25^{\circ}C$

	PARAMETER		TEST CONDITIONS	V _{CCA} = V _{CCB} = 1.5 V	V _{CCA} = V _{CCB} = 1.2 V	V _{CCA} = V _{CCB} = 1.8 V	$V_{CCA} = V_{CCB} = 2.5 V$	V _{CCA} = V _{CCB} = 3.3 V	UNIT
	A 1 - B	Outputs enabled		1	1	1	2	2	
C (1)	A to B C _{pdA} ⁽¹⁾	Outputs disabled	$C_L = 0,$	1	1	1	1	2	»Г
	P to A	Outputs enabled	$f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$	19	19	20	21	22	pF
	C	Outputs disabled		1	1	1	1	1	
	A to B	Outputs enabled		19	19	20	21	22	
C (1)	AIOB	Outputs disabled	$C_{L} = 0,$ $f = 10 \text{ MHz},$ $t_{r} = t_{f} = 1 \text{ ns}$	1	1	1	1	1	pF
C _{pdB} ⁽¹⁾	P to A	Outputs enabled		1	1	1	2	2	рг
	B to A Outputs disabled			1	1	1	1	2	

⁽¹⁾ Power dissipation capacitance per transceiver



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

ENABLE AND DISABLE TIMES

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_0 = 50 Ω , $dv/dt \geq$ 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

PROPAGATION DELAY TIMES

Figure 1. Load Circuit and Voltage Waveforms





ti.com 18-Jul-2006

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
SN74AVC24T245GRGR	ACTIVE	BGA MI CROSTA R JUNI OR	GRG	83	1000	TBD	SNPB	Level-1-240C-UNLIM
SN74AVC24T245ZRGR	ACTIVE	BGA MI CROSTA R JUNI OR	ZRG	83	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AVC24T245GRGR	BGA MI CROSTA R JUNI OR	GRG	83	1000	330.0	24.4	4.8	10.3	1.8	8.0	24.0	Q1
SN74AVC24T245ZRGR	BGA MI CROSTA R JUNI OR	ZRG	83	1000	330.0	24.4	4.8	10.3	1.8	8.0	24.0	Q1



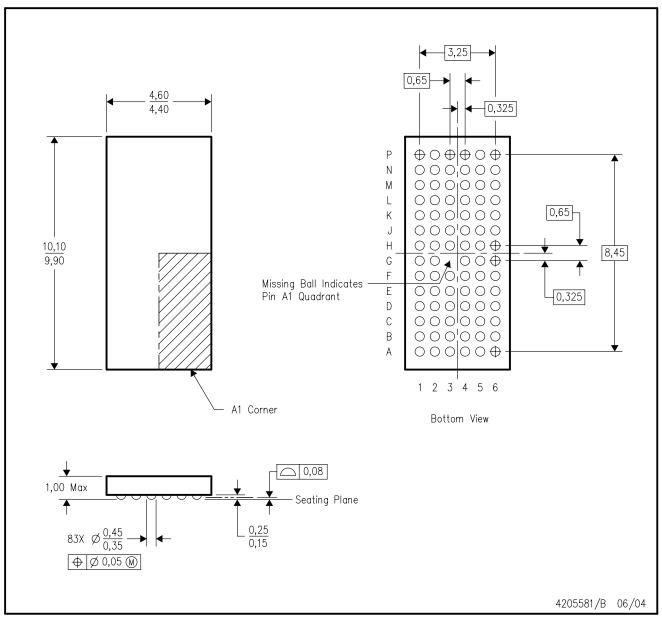


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AVC24T245GRGR	BGA MICROSTAR JUNIOR	GRG	83	1000	333.2	345.9	31.8
SN74AVC24T245ZRGR	BGA MICROSTAR JUNIOR	ZRG	83	1000	333.2	345.9	31.8

GRG (R-PBGA-N83)

PLASTIC BALL GRID ARRAY



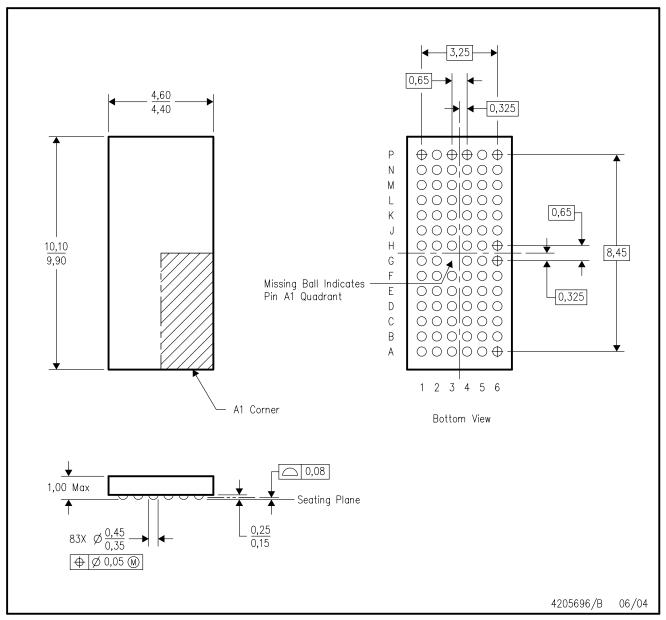
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. JEDEC MO-225 registration is pending.
- D. This package is tin-lead (SnPb). Refer to the 83 ZRG package (drawing 4205696) for lead-free.



ZRG (R-PBGA-N83)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. JEDEC MO-225 registration is pending.
- D. This package is lead-free. Refer to the 83 GRG package (drawing 4205581) for tin-lead (SnPb).



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products Amplifiers amplifier.ti.com Data Converters dataconverter.ti.com DSP dsp.ti.com Clocks and Timers www.ti.com/clocks Interface interface.ti.com Logic logic.ti.com Power Mgmt power.ti.com Microcontrollers microcontroller.ti.com www.ti-rfid.com RF/IF and ZigBee® Solutions www.ti.com/lprf

Applications	
Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated